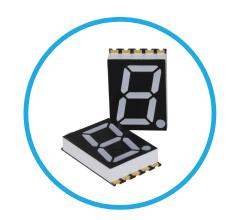


# DSM7T Series Thin Surface Mount Single Digit 7-Segment LED Numeric Display



DSM7TA56105T - 0.56" (14.22mm) Digit Height Emitting Color: Pure-Green (InGaN)













## **Applications**

- People Movers
- Home Appliances
- Medical Devices

- Industrial Devices
- Automation and Controls
- Light Control

- IoT
- Transportation
- Food Service Appliances

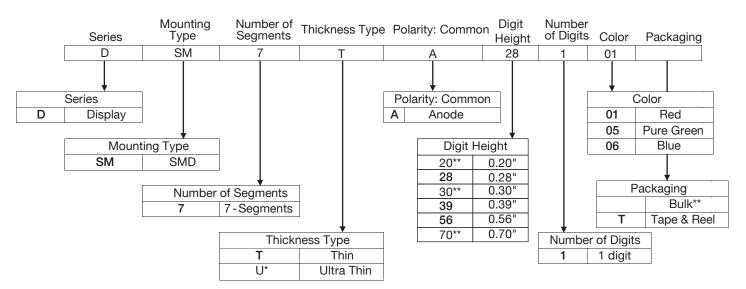
# **Key Features**

- •1-digit seven segment led numeric display
- Includes a decimal point (DP), useful when two or more seven-segment displays are connected to each other to display decimals
- · White segments and black surface
- Substrate: InGaN
- Outer dimensions: 17.0 x 12.5 x 3.85mm
- High light output
- Excellent character appearance
- Quality tested with the highest industry standard
- Side by side mounting allows space saving
- Provides the ability to reduce overall thickness of PCB, with major cost savings
- Display surface color: black surface and white segments

- Available in 3 different digit heights and widths
- Automation-friendly tape and reel
- Technically and mechanically rugged
- · Small and light, easy assembly
- Life expectancy: up to 50,000 hours
- Lower power consumption
- Allow top mount and reverse mount design
- Mechanically rugged
- · Moisture Sensitive Level (MSL): 2a
- Available in blue, red and pure green
- · Polarity: common anode
- Easy mounting on PC boards or sockets
- Low current operation
- Degree of protection IP50 (Dust-Protected)



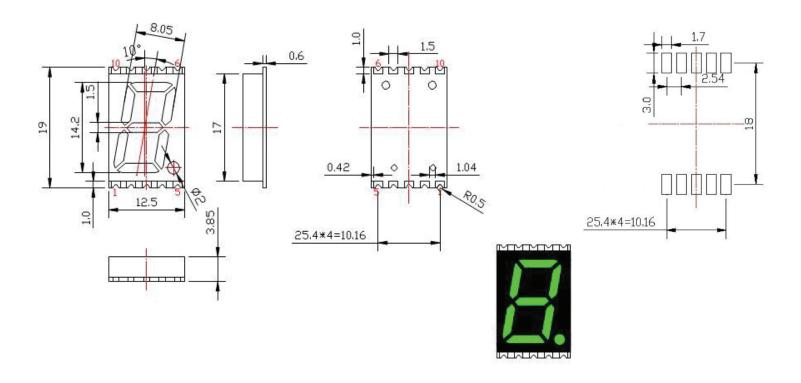
## **Ordering Data**



\*Please refer to DSM7U product datasheet for Ultra Thin Version

\*\*Only available for DSM7U Version

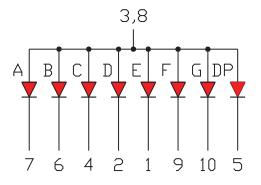
## Dimensions and Internal Circuit Diagram



 $\label{eq:Dimensions} \mbox{Dimensions in millimeters}$   $\mbox{Tolerance is $\pm 0.25 mm unless otherwise noted}$ 

# Internal Circuit Diagram

# Pin Connections (Common Anode)



PIN No	Connection	
1	CATHODE E	
2	CATHODE D	
3	COMMON ANODE	
4	CATHODE C	
5	CATHODE DP	
6	CATHODE B	
7	CATHODE A	
8	COMMON ANODE	
9	CATHODE F	
10	CATHODE G	

# **Product Specifications**

## Absolute Maximum Ratings while Ta=25°C

Parameter	Minimum (m)	Maximum (M)	Unit
Forward Current I <sub>F</sub> /Seg		20	mA
Reverse Voltage V <sub>R</sub> /Seg		5	V
Operating Temperature T <sub>OPR</sub>	-30	+85	°C
Storage Temperature T <sub>STG</sub>	-40	+100	°C
Peak Current I <sub>FM</sub> /Seg		60	mA

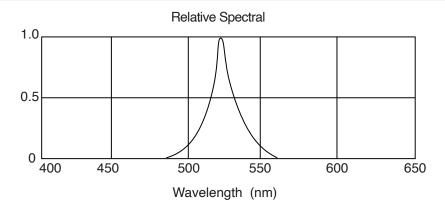
(Notice: 1/10th duty cycle, 0.1ms pulse width)

## Electrical-Optical Characteristics while Ta=25°C

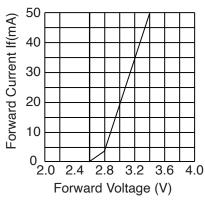
Parameter	Condition	Unit	Minimum	Typical	Maximum
Forward Voltage V <sub>F</sub> /Seg	IF=20mA	V	2.6	3.0	3.6
Reverse Current I <sub>R</sub> /Seg	VR=5V	μΑ			50
Wavelength λP	IF=20mA	nm	520	525	530
Full Width at Half	IF=20mA	nm		17.5	
Maximum Δλ					
Luminosity I <sub>v</sub> /Seg	IF=20mA	mcd	100	150	220
Viewing angle	wide viewing angle				

## **Product Specifications**

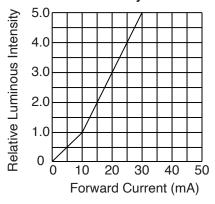
Relative Luminous Intensity @ 20mA



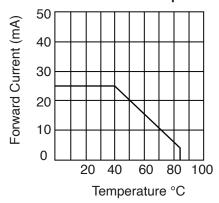
#### Forward Current vs. Forward Voltage



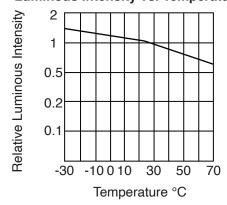
**Relative Luminous Intensity vs. Forward current** 



#### **Forward Current Vs. Temperature**

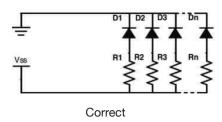


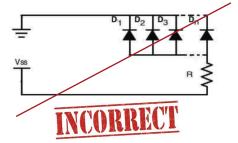
#### **Luminous Intensity vs. Temperature**



# Circuit Design Notes

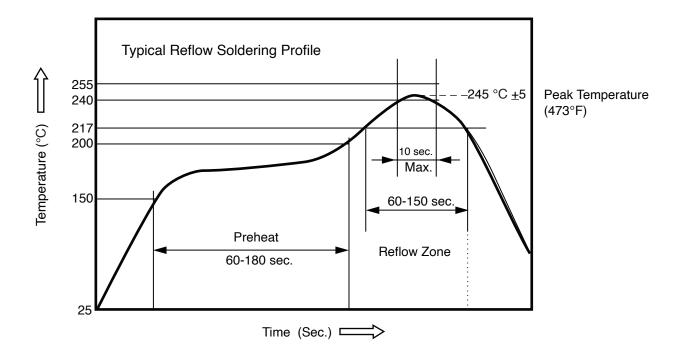
- · Always use current limit resistors when necessary
- LEDs could be electrically connected in parallel, with each current limiting resistor







## Recommended Reflow Soldering Profile



Profile Feature	Typical Parameters		
Preheat Temperature Min	150 °C (302°F)		
Preheat Temperature Max	200 °C (392°F)		
Preheat Time	60 -180 sec.		
Reflow Starting Temperature	217 °C (423°F)		
Time Spent During Reflow	60 -150 sec.		
Reflow Peak Temperature	245 °C (473°F)		

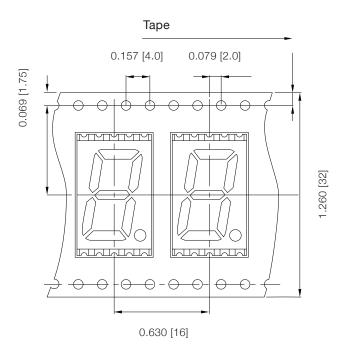
- · Manual soldering is suggested
  - Use soldering irons of which power is less than 30 Watt.
  - Keep the temperature of soldering irons below 360 °C
  - Only one soldering is allowed on each bonding pad.
  - The maximum time from when a soldering iron comes into contact with the parts that are to be connected until the joint is finished should not exceed three seconds.
  - Perform other procedures after the soldered pad cools down.
- Suggested storage conditions: 25°C +/-10°C (77°F +/-50°F), relative humidity 65% RH +/- 20% RH.

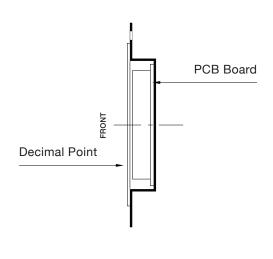


# Tape and Reel Dimensions

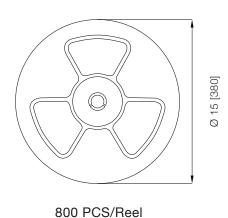
#### Carrier band

## Electrostatic Discharge (ESD) Package Anti Static Bags Aluminium Moisture Barrier Bag.

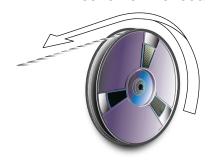




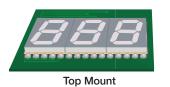
#### **Reel Dimensions**



Direction of the feed



Allow top mount or reverse mount design





Dimensions in inches [millimeters]

## Compliances and Approvals









